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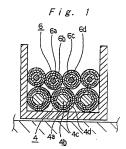
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(54)MULTILAYER INSULATED WIRE AND TRANSFORMER USING THE SAME

(57) A multilayer insulated wire having two or more extrusion-insulating layers provided on a conductor to coat the conductor, wherein at least one layer of the insulating layers is composed of a polyethersulfone resin (i), or a resin mixture (ii) made by blending: 100 parts by weight of a resin (A) of at least one selected from polyetherimide resins and polyethersulfone resins, and 10 parts by weight or more of a resin (B) of at least one selected from polycarbonate resins, polyarylate resins, polyester resins and polyamide resins; and wherein at least one layer other than the insulating layer composed of the resin (i) or resin mixture (ii) is provided as an outer layer to the insulating layer and is composed of a polyphenylenesulfide resin. A transformer in which the insulated wire is used.



Description

TECHNICAL FIELD

5 [0001] The present invention relates to a multilayer insulated wire whose insulating layers are composed of two or more extrusion-coating layers. The present invention also relates to a transformer in which the multilayer insulated wire is utilized.

BACKGROUND ART

[0002] The structure of a transformer is prescribed by IEC (international Electrotechnical Communication) Standards Pub. 60950, and the like. That is, these standards provide that at least three insulating layers be formed between primary and secondary windings in a winding, in which an enamel film which covers a conductor of a winding be not authorized as an insulating layer (an insulation thin-film material), or that the thickness of an insulating layer be 0.4 mm or more. The standards also provide that the recepage distance between the primary and secondary windings, which varies depending on the applied voltage, be 5 mm or more, that the transformer withstand a vottage of 3.000 V applied between the primary and secondary sides for a minute or more, and the like,

[0003] According to such the standards, as a currently prevailing transformer has a structure such as one illustrated in a cross-sectional view of Fig. 2. In the structure, an enameled primary winding 4 is wound around a bobble 2 on a 200 per first core 1 in a manner such that insulating barriers 3 for securing the creepage distance are arranged individually on the opposite sides of the operitheral surface of the bobble. An insulating tape 5 is wound for at least three turns on the primary winding 4, additional insulating barriers 3 for securing the creepage distance are arranged on the insulating tape, and an enameled secondary winding 6 is then wound around the insulating tape.

[0004] Recently, a transformer having a structure which includes neither the insulating barriers 3 nor the insulating to tape layer 5, as shown in Fig. 1, has started to be used in place of the transformer having the structure shown in the cross-section of Fig. 2. The transformer shown in Fig. 1 has an advantage over the one having the structure shown in Fig. 2, in being able to be reduced in overall size and dispense with the winding operation for the insulating tape.

[0005] In manufacturing the transformer shown in Fig. 1, it is necessary, in consideration of the aforesaid IEC standards, that at least three insulating layers 4 (66), 4 ce/6, and 4d (60) are formed on the outer peripheral surface on one or both of conductors 4 a (6a) of the primary winding 4 and the secondary winding 6 used.

[0008] As such a winding, a winding in which an insulating tape is first wound around a conductor to form a first insulating layer thereon, and is further wound to form second and third insulating layers in succession, so as to form three insulating layers that are separable from one another, is known. Further, a winding in which a conductor is successively extrusion-coated with a fluororesin, in place of an insulating tape, whereby extrusion-coating layers composed of three-layer structure in all are formed for use as insulating layers, is known.

[0007] In the above-mentioned case of winding an insulating tape, however, because winding the tape is an unavoldable operation, the efficiency of production is extremely low, and thus the cost of the electrical wire is conspicuously increased.

[0008] In the above-mentioned case of extrusion of a fluoronsein, since the insulating layer is made of the fluoronsein, of the third is the advantage of good heat resistance. On the other hand, because of the high cost of the resis and the property that when it is pulled at high shearing speed, the state of the external appearance is deteriorated, it is difficult to increase the production speed, and like the insulating tape, the cost of the electric wive becomes high.

[0009] To solve such a problem, a multilayer insulated wire is put to practical use, in which the outer poriphery of a conductor is coated, by actuation, with a modified polyester resin of which the crystalization is controlled, and which can be restricted in a reduction in molecular weight, as the first and second insulating layers, and with a polyamide resin as the third insulating layer. Moreover, as a multilayer insulated wire that is more improved in heat resistance, those produced by extrusion-coating with a polyethersultone resin as the inner layer, and with a polyamide resin as the ottermost layer, are proposed.

[0010] However, along with rocent development of small-sized and high-density electric and electronic machineries and tools, there has been concern about the Influence of the heat generated from constituted parts, and the influence of impaired radiating ability. Therefore, higher heat resistance, high chemical resistance, such as resistance to a solvent, from the viewpoint of handling, and also improvements in life time and corona resistance also as to electrical properties, are required. However, insulated wires fulfilling a of these requirements have not been realized at prosection.

DISCLOSURE OF INVENTION

[0011] The present invention is a multilayer insulated wire having two or more extrusion-insulating layers provided on a conductor to coat the conductor.

wherein at least one layer of the insulating layers is composed of a polyethersulfone resin, and

wherein at least one layer other than the at least one insulating layer is provided as an outer layer to the at least one insulating layer and is composed of a polyphenylenesulfide resin.

[0012] Further, the present invention is a multilayer insulated wire having two or more solderable extrusion-insulating layers provided on a conductor to coat the conductor,

wherein at least one layer of the insulating layers is composed of a resin mixture made by blending; 100 parts by weight of a rean (A) of all beats one selected from the group consisting of a polyetherimide resin and a polyether-sulfone resin, and 10 parts by weight or more of a resin (8) of at least one selected from the group consisting of a polyetherization resin, and 10 parts by weight or more of a resin (8) of at least one selected from the group consisting of a polyearborate resin, and the polyearborate resin and a polyearborate resin and a polyearborate resin, and the polyearborate resin and a polyearborate resin and a polyearborate resin, and the polyearborate resin and a polyearborate resin, and the polyearborate resin and a polyearborate resin, and the polyearborate resin and a polyearborate

wherein at least one layer other than the at least one insulating layer composed of the resin mixture is provided as an outer layer to the at least one insulating layer and is composed of a polyphenylenesulfide resin.

[0013] Further, the present invention is a transformer, in which any one of the above multilayer insulated wire is used. [0014] Other and further features and advantages of the invention will appear more fully from the following description, taken in connection with the accompanying drawings.

BRIFE DESCRIPTION OF DRAWINGS

[0015]

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Fig. 1 is a cross-sectional view illustrating an example of the transformer having a structure in which three-layer insulated wires are used as windings.

Fig. 2 is a cross-sectional view illustrating an example of the transformer having a conventional structure.

BEST MODE FOR CARRYING OUT THE INVENTION

[0016] According to the present invention, there is provided the following means:

- (1) A multilayer insulated wire having two or more extrusion-insulating layers provided on a conductor to coat the conductor.
- conductor,
 wherein at least one layer of the insulating layers is composed of a polyethersulfone resin, and
 - wherein at least one layer other than the at least one insulating layer is provided as an outer layer to the at least one insulating layer and is composed of a polyphenylenesulfide resin.
 - (2) A multilayer insulated wire having two or more solderable extrusion-insulating layers provided on a conductor to coat the conductor.
 - wherein at least one layer of the insulating layers is composed of a resin mixture made by blending; 100 parts by weight of a resin (A) of a least one selected from the group consisting of a polywherthridine senial poly

wherein at least one layer other than the at least one insulating layer composed of the resin mixture is provided

- as an outer layer to the at least one insulating layer and is composed of a polyphenylenesulfide resin.

 (3) The multilayer insulated wire as stated in the above item (2), wherein the resin (A) is a polyethersulfone resin.
- (4) The multilayer insulated wire as stated in the above item (2), wherein the resin (B) is a polycarbonate resin.
- (5) The multilayer insulated wire as stated in the above Item (2), wherein the resin (A) is a polyethersulfone resin and the resin (B) is a polyectromate resin.
- (6) The multilayer insulated wire as stated in any one of the above items (2) to (5), wherein the resin mixture is made by blending: 100 parts by weight of the resin (A), and 10 to 70 parts by weight of the resin (B).
- (7) The multilayer insulated wire according to any one of the above items (1) to (6), wherein the polyphenyle-nesulfide resin to form the at least one insulating layer initially has a loss modulus that is two or more times a storage modulus, at 300°C and 1 rad/s in a nitrogen amosphere.
- (8) The multilayer insulated wire according to any one of the above items (1) to (7), wherein the outermost layer among the insulating layers is composed of a polyphenylenesulfide resin.
 - (9) The multilayer insulated wire according to any one of the above items (1) to (8), wherein the at least one insulating layer is composed of a mixture made by blending: 10 to 85 parts by weight of an inorganic filler, and 100 parts by weight of the polyethersulfone resin or the resin mixture of the resins (A) and (B).
- (10) A transformer, comprising the multilayer insulated wire according to any one of the above items (1) to (9).
 - [0017] The present invention will be described in detail below.
 - [0018] In the multilayer insulated wire of the present invention, the insulating layers are composed of two or more

layers, preferably three layers.

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[0019] In an insulating layer, an arbitrarily polyethersulfone resin, as a resin having high heat resistance, may be selected and used from known resins, and those represented by the following formula (1) can be preferably used:

formula (1)

$$R_1 \longrightarrow S_0 = 0$$

wherein R_1 represents a single bond or $-R_2$ -O-, in which R_2 , which may be substituted, represents a phenylene group, a biphenylylene group, or

In which R_3 represents an alkylene group, such as -C-(CH₃)₂- and -CH₂-, and n is a positive integer large enough to give the polymer.

[0020] The method of producing these resins is known per so, and as an example, a manufacturing method in which a dichierod-pheny sulfnop, bisphenol S, and potassium carbonate are receited in a high-holing solvent, can be mentioned. As commercially available resins, for example, SUMINEXEXCEL PES (trade name, manufactured by Sumitomo Chemical Co., Ltd.) and Radiel A trade name, manufactured by BP A-mocol sea the mentioned.

[0021] Other heat-resistant thermoplastic resins and usually used additives, inorganic fillers, processing auxiliaries, colorants and the like may be added to the insulating layer, to the extent that the heat resistance is not impaired.

[0022] As the structure of the insulating layer of the multilayor insulated wire, a insulating layer with two or more layers obtained by extrusion-coating with the polyetherautilone reash is preferable, because heat resistance is ensured. Also, when the conductor is extrusion-coated with the polyetherautilone reash, the conductor may be presented, if necessary. When the conductor is preheated, the temperature is preferably set to 140 °C or less. The adhesion between the conductor and the polyetherautilone reash is more strengthened by carrying out the preheating.

(0023) On the other hand, when solderability is particularly required of an insulating layer, it is priedrable that among the insulating layers, at least one insulating layer composed of the resim incture of the resins (A) and (B) to formed. When heat resistance is regarded as important, all layers except for the outermost layer are preferably composed of this realm indutine.

[0024] As the resin (A), eary one of the polyethersulfione resin having high heat-resistance may be arbitrarily selected and used from known resins. Further, as the resin (A), a polyether/midd resin, can also be used. The polyether/midd resin, as well as the methods of producing the polyether/midds resin, as well as the methods of producing the polyether/midds resin, as known. For example, the polyether/midd resin can be synthesized by solution polycondensation of 2,2*bls(3*4.64-dicantboxyphenoxy)phonyl[propanediacid anhydride and 4.4*d-dismindojhen/midmstand, in ortho-dichlorobargene as a selvent.

[0025] The polyetherimide resin is preferably represented by formula (2):

formula (2)

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wherein R4 and R5, which may be substituted, each represent a phenylene group, a biphenylylene group,

In which R_g represents an alkylene group preferably having 1 to 7 carbon atoms (such as preferably methylene, and propylene (patriously) repreferably begroup/disene), or a neithylthene group, beach of which R_g and R_g may have a substituent, such as an alkyl group (e.g. methyl and ethyl); and m is a positive integer large enough to give the polymer.

[0026] As commercially available resins, for example, ULTEM (trade name, manufactured by GE Plastics Ltd.) can be mentioned.

[0027] In the present invention, by mixing the heat-resistant resin (A) with the resin (B), the resulting resin composition is given solderability.

[0028] The above-metitioned polycarbonate resins, polyarylate resins, polyaster resins, and polyaritide resins, each of which can be used as the resin (B), are not particularly restricted. As the polycarbonate resins, use can be made of those produced by a known method using, for example, dirydric alcohols, phosgare, and the like, as raw materials. As commercially available resins, for example, Levan (trade name, manufactured by GEP flastices Ltd.), Panifice (trade name, manufactured by GEP (harmicals Ltd.), and Uprion (trade name, manufactured by Mistubishi Ges Chemical Co., Inc.) can be mentioned. As the polycarbonate resins that can be used in the present invention, known polycarbonate resins can be used, such as those expresented by formulas (Ltd.).

formula (3)

 $-\begin{bmatrix} -0-R, -0-C \end{bmatrix}$

wherein R7 represents a phenylene group, a biphenylylene group,

in which R₈ represents an alkylene group preferably having 1 to 7 carbon atoms (such as preferably methylene, ethylene, or propylene (particularly preferably isopropylidene)), or a naphthylene group, each of which may have a substituent, such as an alkyl group (e.g. methyl and eithyl); and is a positive integer large enough to give the polymer.

- [0029] Further, the polyanylate resins are generally produced by the interfacial polymerization method, in which, for example, bisphenol of dissolved in an aqueous alkail solution, and a terephthalic chloride/sophthalic chloride mixture dissolved in an organic solvent, such as a halogenated hydrocarbon, are reacted at normal temperature, to synthesize the resin. As commercially available resins, for example, U-polymer (trade name, manufactured by Unitika Ltd.) can be mentioned.
- 5 [0030] Further, as the polyester resins, those produced by a known method using, as raw materials, dihydric alcohols, divalent aromatic carborytic acids, and the like, can be used. As commercially available resins, use can be made of polyethylene torophthalate (PFT)-seriors resins, such as Byropet Itade name, manufactured by Toyobo Co., Ltd.); polyethylene naphthalate (PFN)-series resins, such as Teijin PEN (trade name, manufactured by Teijin Ltd.).
- [0031] Further, as the polyamide resins, those produced by a known method using, as raw materials, diamnine, dicarboxylic acids, and the like, can be used. As commercially available resins, for example, nylon 8,6, such as Amilan (trade name, manufactured by Teray Industries, Inc.), 2ytel (trade name, manufactured by E. I. du Pont DeNemours & Co., Inc.), Maranyl (trade name, manufactured by Unlitika Lttd.); and nylon 6,T, such as ARLEN (trade name, manufactured by Unlitika Lttd.); and nylon 6,T, such as ARLEN (trade name, manufactured by Unlitika Chamilan), can be mentioned.
- [0032] In the present invention, the amount of the resin (8) to be mixed to 100 parts by weight of the resin (A) is 10 for parts by weight or more. When the amount of the resin (B) is less than 10 parts by weight, to 100 parts by weight of the resin (A) is 10, heat resistance is increased but solderability cannot be obtained. The upper limit of the amount of the resin (A) is 0 mixed is deveremented taking the level of the required heat resistance into account, and it is preferably 100 parts by weight or less. When a particularly high level of heat resistance is to be realized while keeping high solderability, the amount of the resin (B) to be used is preferably 2 parts by weight or loss, and a preferable range of the preferably that the amount of the resin (B) to be used is preferably 2 parts by weight or loss, and a preferable range of the preferably that the amount of the resin (B) to be mixed is 20 to 50 parts by weight or loss (A).
- [0033] The above reain composition can be prepared by melting and mixing by using a usual mixer, such as a twinscrew extruder and a co-kneader. It has been found that the mixing temperature of the resins to be mixed has an influence on the direct solderability, and the higher the mixing temperature of the mixer is set at, the better the resulting solderability is. Preferably the mixing temperature is set at \$20° Cor higher, and particularly preferably 360° Cor higher. (0034) Other heat-resistant themoplastic resists and usually used additives, inorganic filters, processing auxiliaries, colorants and the like may be added to the insulating layer, to the extent that the solderability and the heat resistance are not imissing.
- [0035] As the structure of the insulating layer of the multilayer insulated wire, a insulating layer with a combination of of two or more layers obtained by extrusion-coating with the resin mixture is preferable, because of a good balance between the secument of heat resistance and solderability. Further, when the resin mixture is applied to a conductor by extrusion-coating, it is preferable for the resultant solderability that the conductor is not preliminarily heated (preferable). When the conductor is preliminarily heated, preferably the temperature is set to 140 °C or below. This is because the weakening of the adhesion between the conductor and the resin mixture coating layer due to not heating the conductor. In a large heat shrinkage of 10 to 30% of the resin mixture coating layer in the direction of the wire length at the time of soldering, improves the solderability.
- [0036] At least one insulating layer composed of a polyphenylenesulfide resin is formed outside of the insulating layer composed of the polyethersulfone resin or the resin mixture.
- [037] As to the polyphenylenesulfide resin, there is a usual method for producing it by running a polymerizationcondensation reaction between p-dichlorbenzaries and NsS/NHAGH or sodium sulfide in N-methylpyridision, at a
 high temperature under pressure. Examples of the type of polyphenylenesulfide resin include a cross-linked molecular
 construction polymer trype, hereinalter, abbreviated to a cross-linked type, and a finare molecular construction polymer trype. In the case of the cross-linked type, a cyclic oligomer produced during
 the reaction is incorporated into a polymer in a hat crossishing step. The linear type is a polyphenylenesulfide resin instal is made to have a high molecular weight in the course of the reaction using a polymerization agent. The resiswith can beryferefarbly used in the present invention is a polyphenylenesulfide resin minist) containing a finare-chain
 type, in the present invention, it is preferable to use the polyphenylenesulfide resin that initially has the loss modulus.

 1 reads and 300 CF in a finitione at mesophere. As to a method of
 being two or more times the storage modulus. At 1 rad/s and 300 CF in a finitione atmosphere. As to a method of

evaluation, the evaluation is easily made by utilizing an apparatus for measuring the time dependency of the loss modulus and storage modulus. As examples of the apparatus, Ares Measuring Device, manufactured by Reconstrict, Scientific, can be mentioned. The ratio between these two modulus is a standard of cross-inflied elvel. It is sometimes difficult to accomplish modifing processing in the case of a polyphenylenesulfide resin having a loss modulus less than twice the storage modulus.

[0038] The polyphenylenesulfide resin mainly containing a linear type can be processed by continuous extrusionmoting and has a facibility sufficient as the coeting layer of the mutilayer insulated wire. On the other hand, in the
case of the cross-linked type polyphenylenesulfide resin, there is a possibility of the formation of a gelled product during
formation of the polyphenylenesulfide resin mainly containing a linear type with the
cross-linked type polyphenylenesulfide resin, or to further contain, for example, a cross-linked component and a
branched component in the polymer, to the extent that the molding processing is not Inhibited. Herein, the phrase
"mainly containing a linear type" means that the linear type polyphenylenesulfide resin component occupies generally
70 mole's for more, in the whole components of the polyphenylenesulfide resin.

[0039] Further, the polyphenylenesulfide realn, in the case of a flick film, generally has the characteristics that the elengation percentage when it is inputered with tensile is very low, specifically, 1 to 3% in the case of a cross-linked type and 20 to 40% in the case of even a linear type. Therefore, the thick polyphenylenesulfide realn film is unsuitable to the use as the coating material of insulated wires at all. However, the inventors of the present invention have surprisingly found that in the case of a fill-film (103 jun or less) structure such as those used in the present invention, the elongation percentage at the time of tensile rupture can be increased up to 50 to 70%, when the polyphenyle-nesulfide realn mainly containing a linear type is used. If the elongation percentage at the time of tensile rupture is

50% or more, this shows that such a material has flexibility sufficient as the coating material.

[0040] Further, when at least one keyer composed of this polyphenylenesulfide resin is provided outside of the aforementioned insulating layer composed of the polyerherullone resin or the resin mixture, chemical resistance such as solvent resistance can be improved more significantly than in the case of providing no such a layer. Resins such as crystalian resins are known to have strong resistance to chemicals such as solvents. However, such a resin has been found for the first time, which has chemical resistance even in the case of such at this film structure as that used in the present invention, which can be extrusion-molded at a high rate, and which can also possess characteristics as a multilayer insulated wire. As viewing from the point of heat resistance, it is assumed that the polyphenyinesulfide resin has sufficient heat resistance even in the case of a thin-film structure, because it is basically different in oxidation mechanism from other resins such as a polyminid resin having an oxidation mechanism in which oxidation is advanced

to the inside by a deterioration caused by thermal oxidation from the surface.

[0041] Futher, it has been confirmed that the multilayer insulated wire of the present invention has an effect on improvement in life time characteristics among electrical properties. Although it is east/that earth-tracking property is not good in the case of the polyphenylenesulfide resin, it has been found that the life time in a charging test is protonged and the polyphenylenesulfide resin has an effect on coronar resistance, by utilizing the polyphenylenesulfide resin as a part of the insulating layer structure of the multilayer insulated wire in the present invention. This is based on reduction in generation of zone caused by discharging, and beyond inagination from the viewpoint of conventional tenchlogies of molding materials which technologies are cultivated through injection molding and the like. These effects are developed for the first time by using the claimed constitution of the present invention.

40 [0042] Examples of commercially available polyphenylenesulfide resists include Fortron (trade name, manufactured by Polypastics), Dic. PPS (trade name, manufactured by Dainippon Ink & Chemicals, Inc.), and PPS (trade name, manufactured by Dic PP.) Among these resins, for example, Fortron (0220 A8 (grade name)), Dic-PPS (FZ-2200-A5 (grade name)), and Dic EP - PPS (TZ-4P (grade name)) have the following railos of the modulus (i.e. loss modulus) storage modulus) (in a nitrogan atmosphere, it rad/s, 300 °C): 3.5, 3 and 5.9, respectively, and those are threefore

5 preferable.

[0043] Other heat-resistant thermoplastic resins, thermoplastic elastomers, and usually used additives, inorganic fillers, processing auxiliaries, colorants, and the like may be added, to the extent that heat resistance and resistance to chemicals are not impained. When performing mold-processing, a method in which nitrogen is substituted for air may be adopted, to suppress a branching and a crosslinking reaction caused by oxidation in a molding machine.

[0044] Annealing treatment may be carried out according the need, after molding processing. This annealing makes higher crystallinity possible, and further improves resistance to chemicals.

[0045] With regard to the inorganic filler, when it is blended in an amount of 10 to 85 parts by weight, to 100 parts

by weight of the polyethersulfore resin or 100 parts by weight of the resim induce of the adversariation resins (A) and (B), the resultant insultation where an be further improved in electrical properties and the above-defined range is therefore preferable.

[0046] As the inorganic filler, for example, titanium oxide, silica (silicon dioxide), and alumina can be used. As a commercially available product, use can be made of, as itanium oxide, FR-88 (grade name, manufactured by FURU-KAWA CO., LTD., an avorage particle diameter. 0.19 jum); as silica, SK (grade name, manufactured by flatsurmoit, LtD.

an average particle diameter. 1.5 µm); and as alumins, RA-30 (grade name, manufactured by Iwatani International Corporation, an average particle diameter. 0.1 µm). When the amount of the inorganic filler to be added is too small, the effect of the filler on electrical properties is not exhibited, while when the amount is too large, the fixebility required for the multilayer insulated wire is not obtained, and heat resistance is impaired. The addition of the inorganic filler can significantly improve, particularly, the life time.

[0047] As the conductor for use in the present invention, a metal bare wire (solid wire), an insulated wire having an enamel film or a thin insulating layer coated on a metal bare wire, a fullicore stranded wire (a bunch of wires) composed of twisted metal bare wires, or a multicore stranded wire can be chosen articore and the property of the stranded wire can be chosen arbitrarily depending on the desired high-requency application. Alternative, when the number of wires of a multicore wire is large, for example, in a 19-or 37-element wire, the multicore wire (elemental wire) may be in a form of a stranded wire or an on-stranded wire. In the multicore wire (elemental wire) may be in a form of a stranded wire or an on-stranded wire. In the non-stranded wire, for example, multiple conductors that each may be a bare wire or an insulated wire to form the element wire, may be morely gathered (collected) together to buncle up them in an approximately persiled idection, or the bundle of them may be wisted in a very large pitch in each case of these, the cross-section thereof is preferably a circle or an approximate persiled idection, or the bundle of them which were the stranded of the thin insulating layer, a rest that is fastify good in solderability, such as an estermide-modified poly-urethane resin, a ureal-modified poly-urethane resin and a polyested winder series, but and a specifically for example, WO-3405 (trade name, manufactured by Platichië Edek Co) can be used. Further,

28 application of solder to the conductor or plating of the conductor with in is a means of improving the solderability [0048]. To state the structure of a preferable embodiment of the present invention, this multilayer insulated wire can be produced by extrusion-coating the outer periphery of a conductor with a polyethersulfone reain to form a insulating layer having a desired thickness as a first layer, and the osteroid and estimated the coate of the coate of the first insulating layer with a polyethersulfone reain to form an insulating layer with a polyethersulfone reain to form an insulating layer with a polyphersylenesulfide reain to form an insulating layer with a polyphersylenesulfide reain to form an insulating layer with a polyphersylenesulfide reain to form an insulating layer whith a polyphersylenesulfide reain to form an insulating layer within a polyphersylenesulfide reain to form an insulating layer within a polyphersylenesulfide reain insulating layers thus formed is controlled within the range of 80 to 180 μm. This is because the electrical properties of the resulting heat-resistant multilayer insulated with may be greatly lowered to make the wire electrical properties of the resulting heat-resistant multilayer insulated with may be greatly lowered to make the wire of the insulating layers is to this. On the other hand, the solderability may be deteriorated considerably, the overall thickness of the insulating layers is to this. More preferably, the overall thickness of the insulating layers is to this. On the other hand, the solderability has one of the extrusion-insulating layers is in the range of 70 to 150 μm. Preferably, the thickness of each of the above three layers is controlled within the range of 20 to 80 μm.

[0049] Meanwhile, when the solderability is regarded as important, the aforementioned resin mixture to be used in the present invention is applied by extrusion-coating, to form the first and second insulating layers, thereby exhibiting intended properties.

[0050] The multilayer insulated wins of the present invention has at least one layer composed of the polyethersulfone resin, as an insulating layer, and has at least one layer composed of the polyphonylenesulfide resin provided as an outer layer of the above insulating layer, and the multilayer insulated wire can fulfill necessary heat resistance, chemical resistance and higher electrical properties. Further, when the multilayer insulated wire is a type having at least one layer composed of the resin insulating layer and having at least one layer composed of the prophenylenesulfide resin provided outside of the above insulating layer, it can fulfill, also, the solderability, besides the above-mentioned characteristics.

[0051] The transformer of the present invention, in which the multilayer insulated wire of the present invention is used, not only satisfies the IEC 080605 standards, it is also applicable to design severe in the required capitally level, since there is no winding of an insulating tape, such that the transformer can be made small in size and heat resistance is high.

[0632] The multilayer insulated wire of the present invention can be used as a winding for any type of transformer, including those shown in Figs. 1 and 2. In a transformer, generally a primary winding and a secondary winding are usual for a layered manner on a core, but the multilayer insulated wire of the present invention may be applied to a transformer in which a primary winding and a secondary winding are attensively wound (JPA-5-1539 (JPA-7 means unexamined published Japanese patent application)). In the transformer of the present invention, the above multilayer insulated wire may be used as both primary and secondary windings are one of primary and secondary windings. Further, when the multilayer insulated wire of the present invention has two layers (for example, when both of a primary winding and as secondary winding are the two-layer insulated wires, or when one of a primary winding and as secondary winding are as excendary winding as a secondary winding as an example of the control of the two-layer insulated wires. Or the control of the primary winding and as secondary winding are the two-layer insulated wires or the present invention has two layers (for example, when both is the two-layer insulated wires or the present invention has two layers (for example, when both is the two-layer insulated wires or the present invention has two layers (for example, when both is the two-layer insulated wires or the present invention has two layers (for example, when both is the two-layer insulated wires or the present invention has two layers (for example, when both is the two-layer insulated wires or the present invention has two layers (for example, when both is the two-layer insulated wires or the present invention has two layers (for example, when both is the present invention has two layers (for example, when both is the present invention has two layers (for example, when both is the present invention has two layers (for example, when both is the present invention has been as a whinterpresent the present inv

[0053] According to the present invention, can be provided the multilayer insulated wire that is useful as a lead wire and a winding of a transformer, to be incorporated, for example, in electrical and electronic machinery and tools; and

that is excellent in heat resistance and in chemical resistance. Further, in a mileyare methodiment of the insulation material to be used in the insulation player, the present invention can prove the multipley insulated where having such excellent the solidorability and the solidorability and the solidorability that where the solidorability that we solidorability the solidorability that solidorability t

- 5 [0054] According to the present invention, can be provided the multilayer insulated wire that is excellent in heat resistance and chemical resistance, that is improved in life time characteristics as to the electric properties, that is excellent in corona resistance, and that is preferable for industrial production. Further, according to the present invention, can be provided a highly reliable transformer, which is obtained by winding such a multilayer insulated wire.
- [0055] The multilayer insulated wire of the present invention not only satisfactorily fulfills a required level of heat or esistance but also is excellent in solvent resistance and chemical resistance, and therefore enables a wide selection of processes in the post-treatment in succession to winding processing.
 - [0056] Further, according to the multilayer insulated wire of the present invention, a specified resin mixture is applied to at least one insulating layer, whereby soldering can be carried out directly in the processing of terminals.
- [0057] The transformer of the present invention produced by using the aforementioned multilayer insulated wire is excellent in electrical properties and is highly reliable.

EXAMPLES

[0058] The present invention will now be described in more detail with reference to the following examples, but the invention is not limited to these.

Examples 1 to 26 and Comparative Examples 1 to 7

- [0659] As conductors, were prepared, bare wires (solid wires) of annested copper wires of diameter 0.4 mm, and stranded wires, each composed of seven without cores (insulated wires), each made by coating an ennested copper wire of diameter 0.15 mm with an insulating varnish WD-4305 (rade name), manufactured by Hitachi Chemical Co., Ltd., so that the coating thickness of the varnish layer would be 8 jun. The conductors were respectively coated successively, by extrasion-coating, with the resists having the formulations (compositions are shown in terms of parts by weight) for extrusion-coating and the thicknesses to form each of the layers, as shown in Tables 11 o4, thereby preparing multilayer insulated wires (surface treatment; use was made of a refriredrating machine oil).
 - [0061] The aforementioned resin composition was made by mixing, utilizing a 30 mm h win-screw extruder (L/D = 30). [0061] Various characteristics of the resulting multilayer insulated wire were tested and measured according to the following procedures.
- 35 A. Heat resistance (1)
 - [0062] The heat resistance was evaluated by the following test method, in conformity to Annex U (Insulated wires) of Item 2.9.4.4 and Annex C (Transformers) of Item 1.5.3 of 60950-standards of the IEC standards.
- [0063] Ten turns of the multileyer insulated wire were wound around a mandred of diameter 6 mm, under a load of 18 MPa (12 kg/mm²). They were heated for 1 hour, class B, at 255° C (class E, E15° C), class T, 24° C, class
- B. Dielectric Breakdown Voltage
- [0064] The dielectric breakdown voltage was measured in accordance with the twisted pair method of JIS C 3003⁻¹⁹⁶⁴
 11. (2). The results are shown in kV unit. It was considered that it did not pass the test if the breakdown voltage was
 lower than 14 kV.

C. Heat resistance (2)

[0065] The multilayer insulated wires were hvisted in accordance with the twisted pair method of JIS C 30031984 the resultant twisted wire was heated at a temperature of 220°C, Class B, lor 168 hours (7 days), and then the cielectric breakdown voltage was measured. It is indicated that the larger that value is, the higher the heat resistance is. When the ratio of the delectric breakdown voltage after the deterioration to the diselectric breakdown voltage before the heat retained, namely, the residual ratio (%) of the diselectric breakdown voltage after the deterioration, is 50% or more, it.

is considered that the multilayer insulated wire roughly satisfies Heat Resistance Class B of the IEC standards Pub 60172. In the tables, the results are shown by the residual ratio (%) of the aforementioned dielectric breakdown voltage after the sample was deteriorated.

5 D. Solvent resistance

[0068] The sample was evaluated according to JIS C 9000; ¹⁸⁸⁴ 14.1(2), wherein it was disposed in a selvent typione for 30 militaries to confirm the pencil hardness of the coating tilm and whether it was evention or not. The case where no example the pencil hardness was harder than H and no everling was observed was rated as "pass", in the tables, the results of the pencil hardness was harder than H and no everling was observed was rated as "pass", in the tables, the results of the pencil hardness was harder than H and no everling was observed was rated as "pass", in the tables, the results are not passed in the test are shown by the resulting sample of parts shell when the resulted sample was reveiled.

F. Chemical resistance

[0067] After a sample was produced according to a twisted pair method, it was impregnated with a xylene-type varnish TVB2024 (trade name, manufactured by TOSHIBA CHEMICAL CORPORATION) and a stytene monomertype varnish TVB2180T (trade name, manufactured by TOSHIBA CHEMICAL CORPORATION), and then dired. Then, it was observed with the naked eye, to confirm whether or not cracks and the like were occurred on the sample. The case where no damages such as cracks was observed was rated as "bass".

20 F. Solderability

[0068] A length of about 40 mm at the end of the insulated wine was dipped in molten solder at a temperature of 450 °C, and the time (see) required for the adhesion of the solder to the dipped 30-mm-long portion was measured. The shorter the required time is, the more excellent the solderability is. The numerical value shown was the average value of n = 3. The case where this time exceeds 10 seconds was rated as "fail", and the time is preferably within 5 seconds when the film thickness is about 100µm, and within 7 seconds when the film thickness is about 180µm.

G. Life time

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[0069] According to a twisted pair method, a sample was made by twisting the multilayer insulated wire with a bare wire (0.8 mm). Then, the time (hours) required until the sample was short-circulated was measured, while charging at normal temperature at a commercial frequency (50 Hz) and 2 kVmm. Whether an ozone odor was present or not was continued by a functional test, during the course of charging, to confirm whether partial discharge occurred or not for the evaluation of corona resistance.

Table 1							
			Example 1	Example 2	Example 3	Example 4	Example 5
Conductor			Single wire	Twisted wire	Single wire	Single wire	Single wire
Production speed (m/min.	ir.]		100	100	100	100	100
Preheating temperature [C]	ြင့		None	None	None	None	None
	Recin(A)	PES .	100	100	100	100	100
	(2) (10)	PEI	1	1	1	-	1
First lavor		PC	-	1	-	,	1
262	Resin(B)	PAR	-	ı	1	,	1
		PA	1	,	1	1	
	Coating thickness [µm]	kness [µm]	35	35	35	35	30
	Resin(A)	PES	100	100	100	100	100
Second laver	6.0	PEI	1	1	-	,	1
	Resin(B)	PĊ.	1	ı		,	1
	Coating thickness (µm	kness [µm]	35	35	35	35	30
Third layer	Resin-1	PPS-1	100	100	í	1	100
	Resin-2	PPS-2	1	1	100	1	,
	Resin-3	PPS-3	ı	1		100	1
	Resin(A)	PES	1	1	,	-	
	Resin(B)	ည	-	1	1	1	1
		PA	1	1	1	1	
	Coating thickness [µm]	kness [µm]	35	35	35	35	30
Overall coating thickness	38		105	105	105	105	06
Wire appearance			Good	Good	Good	Good	Good
	Class F		Passed	Passed	Passed	Passed	Passed
Heat resistance (1)	Class B		Passed	Passed	Passed	Passed	Passed
	ш		QN	Q	Q	Q	Q
Diefectric breakdown voltage	Ξ		24.5	25.0	26.3	24.5	22.7
Heat resistance (2)	Class B [9	[%]	92	68	06	92	88
Solvent resistance			Passed	Passed	Passed	Passed	Passed
sista			Passed	Passed	Passed	Passed	Passed
Solderability [sec]			QV	ΩN	Q	QN	S

Table 1 (continued)						
			Example 6	Example 7	Comparative example 1	Comparative example 2
Conductor			Single wire	Single wire	Single wire	Single wire
Production speed [m/min.	-		100	100	100	100
Preheating temperature "C	ڼ		None	140	None	None
	Resin (A)	PES	100	100	100	100
	(A)	PEI	1	ı		1
First laver		S	ı	-		
	Resin (B)	PAR	1	ı	,	
		PA	-	1	1	
	Coating thickness [µm]	kness [µm]	9	35	35	35
	Resin (A)	PES	100	100	100	100
Second laver	6.0	PE	1	1	-	
	Resin (B)	PC PC	1	1	1	
	Coating thickness [µm]	kness [µm]	09	35	35	35
		PPS-1	100	100	-	
		PPS-2	ı	1	-	
	ĺ	PPS-3	-	ı	-	
I nird layer	_	PES	1	1	100	1
	Hesin (B)	2	-	1	-	1
		A	ı	1	1	100
	Coating thickness [μm]	kness [µm]	09	35	35	35
Overall coating thickness	8		180	105	105	105
wire appearance			Good	Good	Good	Good
3	Class F		Passed	Passed	Not Passed	Not Passed
Heat resistance (1)	Class B		Passed	Passed	Passed	Passed
	ш		Q	QN ·	Q.	QN
Dielectric breakdown voltage	≧		27.5	25.5	22.0	20.5
Heat resistance (2)	m	%	95	90	06	45
Solvent resistance	-		Passed	Passed	Swelled	Passed
Chemical resistance			Passed	Passed	Cracks occurred	Passed
Solderability [sec]			QQ.	QN	QN	QN

Table 2							
			Example 8	Example 9	Example 10	Example 11	Example 12
Conductor			Single wire	Twisted wire	Single wire	Single wire	Single wire
Production speed [m/min.	min.]		100	100	100	100	100
Preheating temperature (°C	် ပ		None	None	None	None	None
	Resin (A)	PES	100	100	100	100	100
	6.4	PEI	1	1	1	-	1
First layer		PC	40	40	20	40	40
5	Resin (B)	PAR	1	ı	1		1
		PA	1	1	1	1	1
	Coating thickness [μm]	ness [μm]	35	35	33	35	35
	Resin (A)	PES	100	100	100	100	100
Second layer		PE	-	1	1	1	-
5	Resin (B)	PC	40	40	50	40	40
	Coating thickness [µm]	ness [ɪɪm]	33	35	33	33	33
	Resin-1	PPS-1	100	100	100	1	-
	Resin-2	PPS-2	-	1	1	100	-
	Resin-3	PPS-3	1	ı	-	,	100
Third layer	Resin (A)	PES	1	ı	1	1	
	Resin (B)	PC PC	1	1	ı	ı	1
		Ā	1	1	-	1	-
	Coating thickness [µm]	ness [µm]	35	35	34	35	35
Overall coating thickness	ess		103	105	100	103	103
Wire appearance			Good	Good	Good	Good	Good
	Class F		2	Q	QN	ON	QN
Heat resistance (1)	Class B		Passed	Passed	Passed	Passed	Passed
i c	Class E		Q	Q	Q	ON	QV
51	voltage		25.5	28.2	27.4	25.6	25.3
_1	[%]		95	94	94	95	97
Solvent resistance			Passed	Passed	Passed	Passed	Passed
SIST			Passed	Passed	Passed	Passed	Passed
Solderability [sec]			3.0	3.5	3.5	3.0	5.0

lable 2 (continued)						
			Example 13	Example 14	Example 15	Example 16
Conductor			Single wire	Single wire	Single wire	Single wire
Production speed [m/min.	min.]		100	100	100	100
Preheating temperature [°C]	re [°C]		None	None	None	140
	Resin (A)	PES	100	100	50	100
	6.4	PEI	1	1	20	1
First laver		PC	65	1	1	4
	Resin (B)	PAR	1	40	1	-
		PA	1	_	20	-
	Coating thickness [µm]	ess [nm]	35	9	35	35
	Resin (A)	PES	100	100	100	100
Second laver	6.3	PE	-	ŀ	ı	
	Resin (B)	PC	65	40	40	40
	Coating thickness [µm]	ess [nm]	33	09	33	33
	Resin-1	PPS-1	100	100	100	100
	Hesin-2	PPS-2	1	1	ı	1
i	Resin-3	PPS-3	-		-	ı
I nird layer	Resin (A)	PES	1	1	J	
	Resin (B)	PC	1	1	1	1
		PA	-	ı	1	1
	Coating thickness [µm]	ess [mm]	33	9	35	35
Overall coating thickness	ess		101	180	103	103
Wire appearance			Good	Good	Good	Good
	Class F		QN	QN	2	Q
Heat resistance (1)	Class B		Passed	Passed	Passed	Passed
	أ,,,		2	QN	Q	S
Dielectric breakdown voltage	voltage KV		26.3	35.5	24.5	25.0
Heat resistance (2)	%		82	98	90	95
Solvent resistance			Passed	Passed	Passed	Passed
Chemical resistance		-	Passed	Passed	Passed	Passed
Solderability [sec]			3.0	7.0	3.5	5.0

Table 3				
		Example 17	Example 18	Example 19
Conductor		Single wire	Single wire	Single wire
Production speed [m/min.	/min.]	100	100	100
Preheating temperature	rre [*୯]	None	None	None
First layer	Resin (A) PES	-	1	-
		100	100	100
	Resin (B) PC	40	20	40
	PAR	ı	ı	-
	PA	1	ı	1
	thickn	33	33	33
Second layer	Resin (A) PES	ı	100	100
		100	ı	ı
	Resin (B) PC	40	40	40
	thickn	33	33	33
Third layer	Resin-1 PPS-1	100	901	100
-		1	ı	-
	Resin-3 PPS-3	1	ı	1
	(A)	i	ı	
	Resin (B) PC	1	ı	ı
	Αd		1	-
	Coating thickness [µm]	35	35	35
Overall coating thickness	ıess	101	101	101
Wire appearance		Good	Good	Good
Heat resistance (1)	Class F	Q	QN	QN
	Class B	Passed	Passed	Passed
		Q	QN	QN
Dielectric breakdown voltage	voltage [kV]	26.1	25.5	25.3
Heat resistance (2)	[%]	90	96	88
Solvent resistance		Passed	Passed	Passed
St		Passed	Passed	Passed
Solderability [sec]		3.0	3.5	3.5

lable 3 (continued)				
		Comparative	Comparative	Comparative
		example 3	example 4	example 5
Conductor		Single wire	Single wire	Single wire
Production speed [m/min.	/min.]	100	100	100
Preheating temperature	္ရ	None	None	None
First layer	Resin (A) PES	100		
			100	-
	Resin (B) PC	-	1	100
	PAR	1		1
	PA	1		-
	툉	33	33	33
second layer	Resin (A) PES	100	1	
		-	100	
	Resin (B) PC		-	100
	thickn	33	33	33
Third layer		-	1	-
		-	1	-
		1	-	-
_	Resin (A) PES	100	100	-
		-	1	100
	₽ A		1	-
	Coating thickness [µm]	35	35	32
Overall coating thickness	. IBSS	101	101	101
Wire appearance		Good	Good	Good
Heat resistance (1)	Class F	2	QN	Q
_	Class B	Passed	Passed	Not Passed
	ا	QN	Q	Not Passed
Dielectric breakdown voltage	voltage [kV]	25.8	25.4	25.5
Heat resistance (2)	%	94	88	0.5
Solvent resistance		8	8	8
Chemical resistance		Cracks occurred	Cracks occurred	Cracks occurred
Solderability	Sec	20 or more	20 or more	10.0

t ping t							
			Example 20 Example 21	Example 21	Example 22	Example 23	Example 24
Conductor			Single wire	Single wire	Single wire	Single wire	Single wire
Production speed [m/min.	ι/min.]		100	100	100	100	001
Preheating temperature (°C	ture [°C]		None	None	None	None	None
	Resin (A)	PES	100	100	100	100	100
First laver	Resin (B)	PC	40	1	,	45	45
	Inorganic filler	Titanium oxide	1	1	1	-	16
	Coating thickness [µm]	ss [mm]	32	35	35	35	35
	Resin (A)	PES	100	100	100	100	100
Second layer	Resin (B)	PC	40	-	ı	45	45
	Inorganic filler	Titanium oxide	1	15	59	16	16
	Coating thickness [μm]	ss [rm]	33	35	32	35	35
	Resin-1	PPS-1	9	100	100	100	100
	Resin-2	PPS-2	1		1	1	
	Resin-3	PPS-3	ļ.	1			
Third layer	Resin (A)	PES	1	-	1		
	Resin (B)	PC C	_	1	,	1	
		PA	1	1	-	_	
	Coating thickness [µm]	ss [tm]	32	35	35	35	35
Overall coating thickness	cness		103	105	105	105	105
Wire appearance			Good	Good	Good	Good	Good
	Class F		QN	Passed	Passed	QN	ΩN
Heat resistance (1)	Class B		Passed	Passed	Passed	Passed	Passed
	Ì		Q	Q	QN	2	Q
Dielectric breakdown voltage	Ť		25.5	23.5	18.7	22.8	20.8
Heat resistance (2)	Class B L%		94	06	88	92	92
Solvent resistance			Passed	Passed	Passed	Passed	Passed
SISTA			Passed	Passed	Passed	Passed	Passed
			3.5	S	QN	4.5	5.0
The time for			750	Q	ON	>1,000	QN

Table 4 (continued)						
			Example 25	Example 26	Comparative example 6	Comparative example 7
Conductor			Single wire	Single wire	Single wire	Single wire
Production speed (m/min.	min.]		100	100	100	100
Preheating temperature [°C	် (၁)		None	None	None	None
	Resin (A)	PES	100	100	100	100
First laver	Resin (B)	ည	45	45		45
	Inorganic filler	Titanium oxide	1	ı		-
	Coating thickness [um]	ss [tm]	35	35	35	35
	Resin (A)	PES	100	100	100	100
Second layer	Resin (B)	S	45	45	1	45
	Inorganic filler	Titanium oxide	9	60 (silica)	175	175
	Coating thickness [um]	ss [nm]	32	35	35	35
	Resin-1	PPS-1	100	100	-	1
	Resin-2	PPS-2		ı	_	
	Resin-3	PPS-3	1	ı		1
Third layer	Resin (A)	PES	1	1	100	100
	Resin (B)	₂	1	1	1	-
		PA	1	ı		-
	Coating thickness [µm]	ss [im]	35	35	35	35
Overall coating thickness	ess		105	105	105	105
Wire appearance			Good	Good	Good	Good
	Class F		Q	QN	Not Passed	Not Passed
Heat resistance (1)	Class B		Passed	Passed	Not Passed	Not Passed
	1		Q	2	Passed	Passed
Dielectric breakdown voltage	Ť		19.0	20.0	12.5	13.4
Heat resistance (2)	Class B [%]		90	88	35	40
Solvent resistance			Passed	Passed	. В	В
sista			Passed	Passed	Cracks occurred	Cracks occurred
₽ [†]			7.0	7.0	QN	5.0
Life time [hr.]			QN	Q	QN	Q

(Notes) In the tables, "-" means that the component was not added, and "ND" means that the test was not carried out.

[0070] The abbreviation representing each resin was as follows:

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PES: SUMIKAEXCEL PES 3600 (trade name, manufactured by Sumitomo Chemical Co., Ltd.), a polyethersulfone resin:

PEI: ULTEM 1000 (trade name, manufactured by GE Plastics Ltd.), a polyetherimide resin;

PC: Lexan SP-1010 (trade name, manufactured by GE Plastics Ltd.), a polycarbonate resin:

PAR: U-polymer (trade name, manufactured by Unitika Ltd.), a polyarylate resin;

PA: ARLEN AE-4200 (trade name, manufactured by Mitsui Chemical), a polyamide resin;
PPS-1: Dic. PPS FZ2200-A5 (trade name, manufactured by Dainippon Ink & Chemicals, Inc.), tanô=3.5, a polyphe-

PPS-3: LT-4P (trade name, manufactured by DIC EP), tanδ =5.9, a polyphenylensuilfide resin.

nylenesulfide resin;
PPS-2: Fortron 0220 A9 (trade name, manufactured by Polyplastics), tan\$ =3.5, a polyphenylenesulfide resin;

[0071] Herein, tanδ represents the ratio of (loss modulus/storage modulus).

[0072] The following facts are apparent from the results shown in Table 1.

[0073] Examples 1 to 7 exhibited good heat resistance and also had very good characteristics as to the solvent

resistance and chemical resistance, since among the three layers, the two under layers were composed of the polyethersulfone resin and the outermost layer was composed of the polyphenylenesulfide resin. [0074] However, in Comparative Example 1, since all of the three layers were composed of only the polyethersulfone

resin, a higher level of heat resistance was not attained, the coating tim was softened in respect to the solvent resistance, and cracks occurred in respect to the chemical resistance. In Comparative Example 2, the outermost layer was composed of the polyamido resin, and resistance to solvents and chemicals were whibited. However, the heat resistance old in ot reach an intended level, and this comparative example scarcely passed heat resistance Class B of the above heat resistance (2) since, for example, thermal deterioration progressed from the surface.

[0075] From the results shown in Tables 2 and 3, the following facts are apparent.

[0075] Examples 8 to 19 exhibited good solderability and heat resistance and also had very good characteristics as a 5 to the solvent resistance and chemical resistance, since among the time leaves, the two layers were composed of the rasin mixture of the resins (A) and (B) falling within the range as defined in the present invention and the outermost.

[0077] On the contrary, Comparative Example 3 had the structure obtained using only the polyethersulfone resin, and Comparative Example 4 and the structure obtained using a combination of the polyethershide resin and the polyethersulfore resin. Although both of these comparative examples exhibited high heat resistance, they had such draw-backs that a solder did not stuck thereto in respect to the soldershift, that the coalisin film was to so fit in respect to

the solvent resistance, and that cracks occurred in respect to the chemical resistance.

[0078] Comparative Example 5 was constructed by composing only the polycarbonate resin. Comparative Example 5 therefore had almost no heart resistance, and it was poor in each of soliderability, solvent resistance and chemical

45 resistance. Therefore, Comparative Example 5 could not reach the practical level.

[0079] Further, the following facts are apparent from the results shown in Table 4.

[0080] Each of Examples 21 to 26 had a structure in which among the three layers, the two under layers were composed of a composition dotained by blending the inorganic filler to the polyethersulfione resin or to the resin mixture of the resins (A) and (B) falling within the range defined in the present invention, and the outermost layer was composed.

of the results (v) and (c) fraining within the range demander in its present in without, and in the other through expenditure of the polyphyriyenesulfide resin. When the amount of the inorganic filler was within the range preferable in the present invention, each example exhibited good heat resistance and further had very good characteristics as to the solvent resistance and exhibited produced the resistance of the resistance and further had very good characteristics as to the solvent resistance and chemical resistance. Examples 23 to 26 also had good solderability.

[0081] On the contrary, in the case of Comparative Examples 5 and 7, the floxibility was adversely affected, since the outermost layer was composed of the polyethersulfone resh and the amount of the inorganic filler was large. Therefore, the heat resistance did not reach an intended level, and such problems that the coating film was too soft in respect to the solvent resistance and cracks occurred in respect to the chemical resistance, were accompanied in these comparative examples.

[0082] Example 20 had a long life time, and Example 23 in which the inorganic filler was utilized was further improved

in life time and almost no ozone odor was generated during the test.

INDUSTRIAL APPLICABILITY

- [0083] The multilayer insulated wire of the present invention, which is excellent in heat resistance and in chemical resistance, is useful as a lead wire or a winding of a transformer, to be incorporated, for example, in electrical and electronic machinery and tools.
 - [0084] Further, the transformer of the present invention is preferable as a transformer high in reliability.
 - [0085] Having described our invention as related to the present embodiments, it is our intention that the invention not be limited by any of the details of the description, unless otherwise specified, but rather be construed broadly within its spirit and scope as set out in the accompanying claims.

Claims

15

- A multilayer insulated wire having two or more extrusion-insulating layers provided on a conductor to coat the conductor,
- wherein at least one layer of the insulating layers is composed of a polyethersulfone resin, and
 wherein at least one layer other than said at least one insulating layer is provided as an outer layer to said
 at least one insulating layer and is comosed of a polyherwlenesulfide resin.
 - A multilayer insulated wire having two or more solderable extrusion-insulating layers provided on a conductor to coat the conductor.
 - wherein at least one layer of the insulating layers is composed of a resh mixture made by blending; 100 parts by weight of a resin (A) of a least one selected from the group consisting of a polyetherfinide resin and a polyethersulfone resin, and 10 parts by weight or more of a resin (B) of at least one selected from the group consisting of a polyecarbonate resin, a polyequist persin, a polyeter resin and a polyetime resin, and
 - wherein at least one layer other than the at least one insulating layer composed of the resin mixture is provided as an outer layer to the at least one insulating layer and is composed of a polyphenylenesulfide resin.
 - 3. The multilayer insulated wire as claimed in claim 2, wherein the resin (A) is a polyethersulfone resin.
 - 4. The multilayer insulated wire as claimed in claim 2, wherein the resin (B) is a polycarbonate resin.
 - The multilayer insulated wire as claimed in claim 2, wherein the resin (A) is a polyethersulfone resin and the resin (B) is a polycarbonate resin.
 - The multilayer insulated wire as claimed in any one of claims 2 to 5, wherein the resin mixture is made by blending: 100 parts by weight of the resin (A), and 10 to 70 parts by weight of the resin (B).
 - 7. The multileyer insulated wire as claimed in any one of claims 1 to 6, wherein the polyphenylenesulfide resin to form the at least one insulating layer initially has a loss modulus that is two or more times a storage modulus, at 30°C°C and 1 rad/s in a introgen atmosphere.
- 8. The multilayer insulated wire as claimed in any one of claims 1 to 7, wherein the outermost layer among the insulating layers is composed of a polyphenylenesulfide resin.
 - The multilayer insulated wire as claimed in any one of claims 1 to 8, wherein the at least one insulating layer is composed of a mixture made by blending; 10 to 85 parts by weight of an inorganic filter, and 100 parts by weight of the polyathorsulfone resin or the resin mixture of the resin (A) and the resin (B).
 - 10. A transformer, comprising the multilayer insulated wire according to any one of claims 1 to 9.

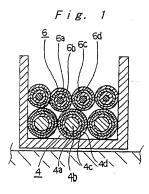
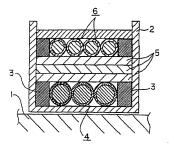


Fig. 2



INTERNATIONAL SEARCH REPORT

International application No.

			PCT/JP02/05379					
	SIFICATION OF SUBJECT MATTER .C1 H01B7/02, H01F27/28							
According	to International Patent Classification (IPC) or to both	national classification an	d IPC					
	S SEARCHED							
Minimum o Int	documentation scarched (classification system followe .C1 ⁷ H01B7/02, H01F27/28	d by classification symbo	ols)					
Jits Koka	tion searched other than minimum documentation to t uyo Shinan Koho 1926-1996 i Jitsuyo Shinan Koho 1971-2002	Toroku Jitsuyo Jitsuyo Shina	o Shinan Koh n Toroku Koh	o 1994-2002 o 1996-2002				
	data base consulted during the international search (na	me of data base and, who	re practicable, sea	rch terms used)				
	MENTS CONSIDERED TO BE RELEVANT							
Category*	Citation of document, with indication, where a			Relevant to claim No.				
Y .	JP 10-125140 A (Furukawa El 15 May, 1998 (15.05.98), Full text (Family: none)	ectric Co., Lt	:d.),	1-10				
Y	JP 4-345703 A (Sumitomo Elec 01 December, 1992 (01.12.92) Full text (Family: none)	tric Industrie	s, Ltd.),	1-10				
Y	JP 4-245110 A (Sumitomo Electric Industries, Ltd.), 30 January, 1992 (30.01,92), Page 3, left column, line 36 (Family: none)		1-10					
▼ Purthe	er documents are listed in the continuation of Box C.	See patent family	y annex.					
"A" docume consider "E" dearlier docume cited to special "O" docume means docume than the Date of the as	statigents of cross disconnection of crisistent programs of the set whether is not refer to be of principles reference on the last whether is not refer to be of principles reference to previously set when the processor but published on or either the instrument of the programs when the programs of the programs when the programs of the set when the programs or either interference or either	priority date and as understand the pris document of partic considered novel on zicp when the docu ricp when the docu considered to mind combined with one combination being "&" document of partic combination being document member. Date of mailing of the i	at in conflict with this niple or theory under plat relevance; the cla- remote the consider ment is taken alone silar relevance; the cla- re an investive step or more other such a obvious to a person of the same patent fit	aimed invention cannot be d to involve an inventive simed invention cannot be when the document is locuments, such skilled in the art mily				
Japar	ailing address of the ISA/ nese Patent Office	Authorized officer						
Facsimile No		Telephone No.		ľ				

Form PCT/ISA/210 (second sheet) (July 1998)

INTERNATIONAL SEARCH REPORT

International application No.
PCT/JP02/05379

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 5426264 A (Baker Hughes Inc.), 20 June, 1995 (20.06.95), Claim 6 4 JP 7-271548 A	1-10
A	EP 0944099 A (Furukawa Electric Co., Ltd.), 22 September, 1999 (22.09.99), 4 WO 99/18583 Al	1-10
A	EP 0949634 A (Furukawa Electric Co., Ltd.), 13 October, 1999 (13.10.99), 4 WO 99/19885 A1	1-10
A	JP 63-29412 A (Sumitomo Electric Industries, Ltd.), 08 February, 1988 (08.02.88), Claims (Family: none)	1-10
A	JP 10-12662 A (Furukawa Electric Co., Ltd.), 22 May, 1998 (22.05.98), Full text (Family: none)	1-10
	-	
M. AUGUSTA		

Form PCT/ISA/210 (continuation of second sheet) (July 1998)

INTERNATIONAL SEARCH REPORT

International application No. PCT/JP02/05379

Box I	Observations where certain claims were found unsearchable (Continuation of item 1 of first sheet)
This int	ternational search report has not been established in respect of certain claims under Article 17(2)(e) for the following reasons:
l. [Claims Nos.:
	because they relate to subject matter not required to be searched by this Authority, namely:
2 🗆	Claims Nos.: because they relate to parts of the international application that do not comply with the prescribed requirements to such an extent that no meaningful international search can be carried out, specifically:
3.	Claims Nos.:
	because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).
Box II	Observations where unity of invention is tacking (Continuation of item 2 of first sheet)
wh shall the g is de inter	ormational Searching Authority found multiple investors in this intermiseral application, as follows: ere a group of invertions is claimed, the requirement of unity of invention to be fulfilled only when there is a special technical feature which links roup of inventions so as to form a single general inventive concept. As associated in the extra sheet, the scope of the claims of the present reactional application describes two inventions classified into claims 1 to 10 and claims 2 to 10.
(cont	inued to extra sheet)
1. 🔀	As all required additional search fees were timely paid by the applicant, this international search report covers all searchable claims.
2. 🗆	As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.
3.	As only some of the required additional search fees were timely paid by the applicant, this international search report covers only those claims for which fees were paid, specifically claims Nos.:
4. 🗀	No required additional search fees were timely paid by the applicant. Consequently, this international search report is restricted to the invention first mentioned in the claims, it is covered by claims Nex.:
Remark	on Pretett The additional tearch fies were accompanied by the applicant's protest. X No protest accompanied the payment of additional search free.

Form PCT/ISA/210 (continuation of first sheet (1)) (July 1998)

INTERNATIONAL SEARCH REPORT

International application No. PCT/JP02/05379

Continuation of Box No.II of continuation of first sheet(1)

Where a group of inventions are claimed, the requirement of unity of invention shall be fulfilled only when there is a special technical feature which links the group of inventions so as to form a single general inventive concept. Since the invention according to claims I includes the case wherein the one of the insulating layers does not comprises a polyethersul fione resin, and accordingly, the inventions according to claims I to lars linked only in the matter "a multilayer insulated wire having an electroconductor and it comprises an insulating layer arranged outside any one of the above-described insulating layers and formed by a polyphenylenesulfide resin".

However, this matter is described in prior technical documents, for example, JP, 4-345703, A [Sumicon Electric Industries], 1992. 12. 01, JP, 8-153420, A (showa Electric Wire & Cable Co., Ltd), 1996. 06. 11, JP, 9-17240, A [Fujikura Ltd), 1997. 01. 17 and JP, 5-97018, D, 1993. 12. 27, and therefore is not the above special technical feature.

Accordingly, there is no special technical feature among a group of inventions according to claims 1 to 10 which links the group of inventions as to form a single general inventive concept. It is clear that a group of inventions according to claims 1 to 10 do not comply with the requirement of unity of invention.

The number of groups of inventions described in the scope of claims in the international application which are so linked as to form general inventive groups, that is, the number of inventions described in the application is now considered. From specific embodiments of the inventions according to independent claims, the scope of claims in this international application describes at least two inventions classified into claim I and wherein one of the insulating layers does not comprises a polyethersulfone resin.

The inventions according to claims 7 to 10 are so linked with an invention according to claim 1 or 2 as to form a single general inventive concept. Accordingly, the scope of the claims of the present international application describes at least two inventions classified into claims 1 and 7 to 10 and claims 2 to 10.

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